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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Loi N. Nguyen, et al.
U.S. Serial No. : 09/712,827
Filed : November 14, 2000
For : METHOD AND INTERLEVEL DIELECTRIC STRUCTURE
FOR IMPROVED METAL STEP COVERAGE
Group No. : 2835
Examiner : (Not Yet Known)

Commissioner of Patents
and Trademarks
Washington, D. C. 20231

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on 3/27/01 (Date)

KATHY LONGENECKER
(Printed or typed name of person signing the certificate)
Kathy Longenecker
(Signature of the person signing the certificate)

Dear Sir:

INFORMATION DISCLOSURE STATEMENT

Pursuant to the duty of disclosure under 37 C.F.R. § 1.56, Applicant submits this statement. This submittal is made in accordance with 37 C.F.R. §§ 1.97 and 1.98 and § 609 of the Manual of Patent Examining Procedure. The patents, publications and other information herein are listed below and on the attached Form PTO-1449. Copies of the listed references are submitted herewith.

<u>U.S. Patent No.</u>	<u>Inventor</u>	<u>Date</u>
4,686,000	Heath	Aug. 11, 1987
4,824,767	Chambers, et al.	Apr. 25, 1989
5,063,176	Lee, et al.	Nov. 5, 1991
5,166,088	Ueda, et al.	Nov. 24, 1992
5,266,516	Ho	Nov. 30, 1993

<u>Foreign Patent No.</u>	<u>Country</u>	<u>Date</u>
JP60246675	Japan	December 6, 1985
JP4196486	Japan	July 16, 1992
0 523 856 A2	Europe	January 20, 1993
JP5074958	Japan	March 26, 1993
0 534 130 A1	Europe	March 31, 1993

Publications

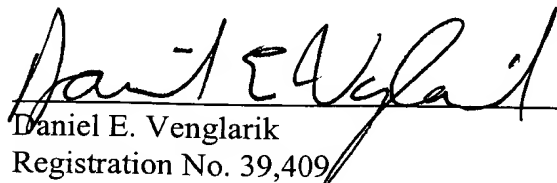
"VLSI Fabrication Principles," by Sorab K. Ghandhi, Rensselaer Polytechnic Institute, A Wiley-Interscience Publication, 1983, pages 479-482; 499-501.

Applicant hereby expressly reserves the right to swear behind the effective dates of any of the above Patents and to question the relevance and materiality of the Patents and Publications listed herein, in whole, in part, or in combination, subsequent to filing this Information Disclosure Statement.

Respectfully submitted,

NOVAKOV DAVIS & MUNCK, P.C.

Date: 3-27-01


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